#### **Descriptions**

The A6226 is a bidirectional low-power dual port, high-speed, USB 2.0 analog switch with integrated protection for USB Type-C<sup>™</sup> systems. The device is configured as a dual 2:1 or 1:2 switch. It is optimized for use with the USB 2.0 DP/DM lines in a USB Type-C<sup>™</sup> system. The device is capable of true isolation. Even when COM+/- overrides VCC, very little current will flow back to the supply.

The A6226 has low bit-to-bit skew and high channel-to-channel noise isolation, and is compatible with various standards, such as high-speed USB 2.0 (480Mbps). Each switch is bidirectional and offers little or no attenuation of the high-speed signals at the outputs. Its bandwidth is wide enough to pass high-speed USB 2.0 differential signals (480 Mb/s) with good signal integrity.

GPIO control of SEL 1.8V logic compatible. The A6226 is available in UQFN 1.4x1.8-10L with Pb-free and Halogen-free making it a perfect candidate for mobile and space constrained applications.

#### **Order Information**

Package		Part Number	Top-Side Marking	
QFN1418(UTQFN-10L(1.4x1.8))	Tape and Reel	SGM7227YUWQ10G/TR	A26 /GYW	

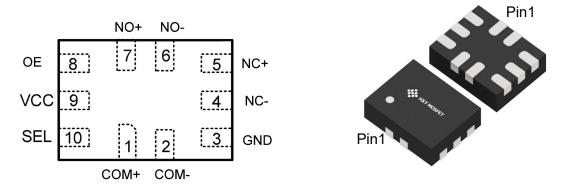
#### **Features**

- Pin-to-Pin FSUSB42, NX3DV42, WAS7227, SGM7227, RS2228, BL1532
- Low On-resistance, Ron=1.5Ω when VCC =5V
- 1.8V Logic Compatible Control Pin
- COM+/- Overrides VCC to Achieve True Isolation Even When Supply Is Dead
- High Off-Isolation: -100dB @ 100KHz
- Low Channel-to-Channel Crosstalk: -97dB @ 100KHz
- High Bandwidth (-3dB @800MHz) Suitable for USB2.0 High-Speed Routing
- Low Quiescent Current (<2uA) With Very Wide Supply Range (1.5V ~ 5.5V)</li>

#### **Applications**

- Anywhere a USB Type-C™ or Micro-B Connector is Used
- Mobile Phones, Tablets and Notebooks

## **Pin Configuration**



QFN1418(UTQFN-10L(1.4x1.8))

### **Functions and Pin Configuration**

Pin			
Number	Symbol	Descriptions	
Nullibei			
1,2	COM <sub>X</sub>	Common Signal Ports	
3	OE	Active Low	
8	GND	Ground	
4,5	NC <sub>X</sub>	Analog/Digital Signal Ports (Normally closed)	
6,7	NOx	Analog/Digital Signal Ports (Normally open)	
9	VCC	Single Power Supply	
10	SEL	Logic Input Selection	

# **Function Descriptions**

Input SEL	Function	
0	NC1=COM1 and NC2=COM2	
1	NO1=COM1 and NO2=COM2	

## Absolute Maximum Ratings (1)

Parameter	Symbol	Value	Unit
Supply Voltage	$V_{CC}$	-0.3 ~ 6.5	V
Control Input Voltage	$V_{\text{IN}}$	-0.3 ~ 6.5	V
Continuous Current Through NO, NC, COM		±100	mA
Peak Current Through NO, NC, COM (pulsed at 1ms 50% duty cycle)		±200	mA
Storage Temperature Range	T <sub>STG</sub>	-55 ~ 150	°C
Junction Temperature under Bias	TJ	150	°C
Lead Temperature (Soldering, 10 seconds)	$T_L$	260	°C
Power Dissipation	$P_D$	250	mW

### Recommend operating ratings (2)

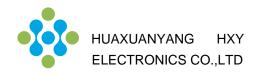
Parameter	Symbol	Value	Unit
Supply Voltage Operating	Vcc	1.5 ~ 5.5	V
Control Input Voltage	V <sub>IN</sub>	-0.3 ~ 5.5	V
Input Signal Voltage	V <sub>COM</sub>	-0.3 ~ 5.5	V
Operating Temperature	T <sub>A</sub>	-40 ~ 85	°C
Thermal Resistance	R <sub>θJA</sub>	360	°C/W

#### Note:

1. "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied.

### Capacitance (Ta=25°C, VCC=3.3V, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Off capacitance	C <sub>OFF</sub>	F=100KHz		5		pF
On capacitance	Con	F=100KHz		7		pF



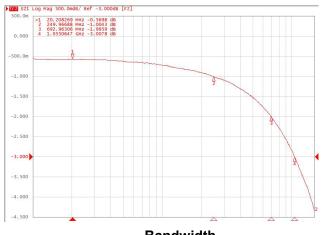
## DC Electronics Characteristics (Ta=25°C, VCC=3.3V, unless otherwise noted)

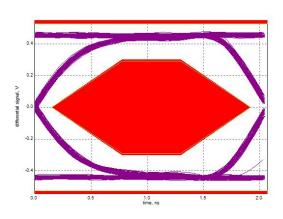
Parameter	Symbol	Conditions	Min.	Тур.	Max	Unit
In a state with the state to state		VCC: 3.3 ~ 5.5V	1.6			V
Input logic high level	V <sub>IH</sub>	VCC: 1.5 ~ 3.3V	1.4			V
Input logic low lovel	\/	VCC: 3.3 ~ 5.5V			0.6	V
Input logic low level	V <sub>IL</sub>	VCC: 1.5 ~ 3.3V			0.4	V
Supply quiescent current	Icc	I <sub>COM</sub> =0, V <sub>IN</sub> =0 or V <sub>IN</sub> =VCC			1.0	uA
Increase in I <sub>CC</sub> per input	Ісст	I <sub>COM</sub> =0, VCC=4.5V V <sub>IN</sub> >1.8 or V <sub>IN</sub> <0.5			1.0	uA
Off state leakage from COM <sub>x</sub> to NC <sub>x</sub> (or NO <sub>x</sub> )	I <sub>COMx</sub>	V <sub>COM</sub> = 5.5V , V <sub>NC(or NO)</sub> = 0V			±2.0	uA
	R <sub>ON1</sub>	V <sub>COM</sub> =0 ~ 0.5V, I <sub>COM</sub> =30mA		3.0	3.5	Ω
	R <sub>ON2</sub>	V <sub>COM</sub> =0.5 ~ 2.0V, I <sub>COM</sub> =30mA		3.6	3.9	Ω
On-Resistance	R <sub>ON3</sub>	V <sub>COM</sub> =2.0 ~ 4.0V, I <sub>COM</sub> =30mA		2.5	3.5	Ω
	R <sub>ON4</sub>	V <sub>COM</sub> =4.0 ~ 5.5V, I <sub>COM</sub> =30mA		1.5	1.8	Ω
	R <sub>FLAT1</sub>	V <sub>COM</sub> =0 ~ 0.5V, I <sub>COM</sub> =30mA		0.7		Ω
	R <sub>FLAT2</sub>	V <sub>COM</sub> =0.5 ~ 2.0V, I <sub>COM</sub> =30mA		0.5		Ω
On-Resistance Flatness	R <sub>FLAT3</sub>	V <sub>COM</sub> =2.0 ~ 4.0V, I <sub>COM</sub> =30mA		1.6		Ω
	R <sub>FLAT4</sub>	V <sub>COM</sub> =4.0 ~ 5.5V, I <sub>COM</sub> =30mA		0.3		Ω
On-Resistance Matching Between Channels	ΔR <sub>ON</sub>	V <sub>COM</sub> =0~5.5V, I <sub>COM</sub> =30mA,		0.1	0.2	Ω

## AC Electronics Characteristics (Ta=25°C, VCC=3.3V, unless otherwise noted)

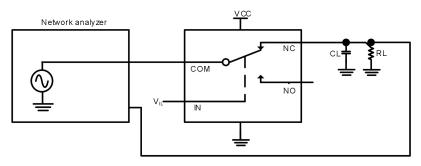
Parameter	Symbol	Conditions	Min.	Тур.	Max	Unit
Turn-On Time	Ton	$V_{COM}$ =1.5V, $C_L$ =35pF, $R_L$ =50 $\Omega$		200		ns
Turn-Off Time	T <sub>OFF</sub>	$V_{COM}$ =1.5V, $C_L$ =35pF, $R_L$ =50 $\Omega$		200		ns
Break-Before-Make time	T <sub>BBM</sub>	$V_{COM}$ =1.5V, $C_L$ =35pF, $R_L$ =50 $\Omega$		500		ns
-3dB Bandwidth	BW	R <sub>L</sub> =50Ω, C <sub>L</sub> =0pF		800		MHz
Off isolation	OIRR	F=1KHz, R <sub>L</sub> =50Ω		-81		dB
On isolation	OIKK	F=10KHz, $R_L$ =50 $\Omega$		-80		dB
Crosstalk	Xtalk	F=1KHz, R <sub>L</sub> =50Ω		-83		dB
Crosstaik	Aldik	F=10KHz, $R_L$ =50 $\Omega$		dB		
Total Harmonic Distortion	TUD	F=20Hz to 20KHz		90		dB
Total Harmonic Distortion	THD	$V_{COM}$ =600m $V$ p-p @ $R_L$ =32 $\Omega$ ,	-80			ub

# Typical Characteristics (Ta=25°C, VCC=3.3V, unless otherwise noted)

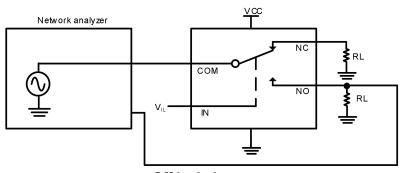




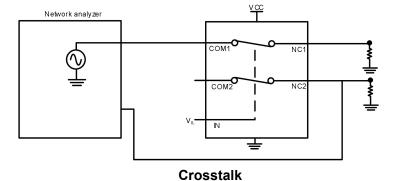
Bandwidth Eye Diagram (480Mbps)



**Bandwidth** 



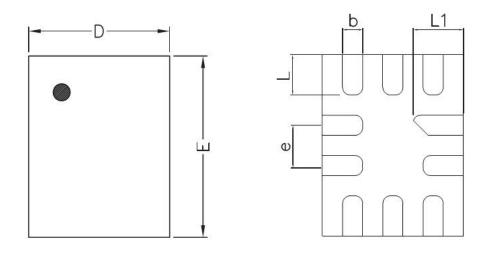
Off isolation

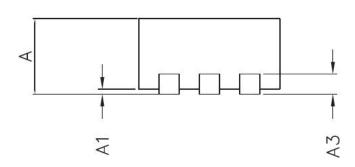




## **Package Outline Dimensions**

# QFN1418(QFN-10(1.8x1.4))





Cymph al	Dimension in Millimeters			
Symbol	Min.	Max.		
А	0.450	0.550		
A1	0.000	0.050		
A3	0.1	52 Ref.		
D	1.350	1.450		
E	1.750	1.850		
b	0.150	0.250		
е	0.4	0.400 Typ.		
L	0.350	0.450		
L1	0.450	0.550		

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